

# Dual P-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

### **General Description**

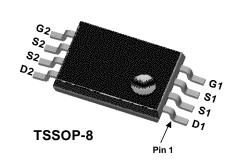
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

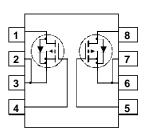
# Applications

- · Load switch
- Motor drive
- DC/DC conversion
- Power management

## Features

- -4.4 A, -20 V.  $R_{DS(ON)} = 0.035 \ \Omega \ @ V_{GS} = -4.5 \ V$  $R_{DS(ON)} = 0.057 \ \Omega \ @ V_{GS} = -2.5 \ V.$
- Extended  $V_{GSS}$  range (±12V) for battery applications.
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$  .
- Low profile TSSOP-8 package.





# Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage			-20	V
V <sub>GSS</sub>	Gate-Sourc	e Voltage		±12	V
I <sub>D</sub>	Drain Curre	nt – Continuous	(Note 1a)	-4.4	A
		<ul> <li>Pulsed</li> </ul>		-30	
PD	Power Diss	ipation for Single Opera	ation (Note 1a)	1.0	W
			(Note 1b)	0.6	
T <sub>J</sub> , T <sub>stg</sub>	Operating a	Dperating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Charac	teristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)			125	°C/W
			(Note 1b)	208	
-		g and Ordering	g Information Reel Size	Tape width	Quantity
Device Marking				•	
250	2P	FDW2502P	13"	12mm	3000 units

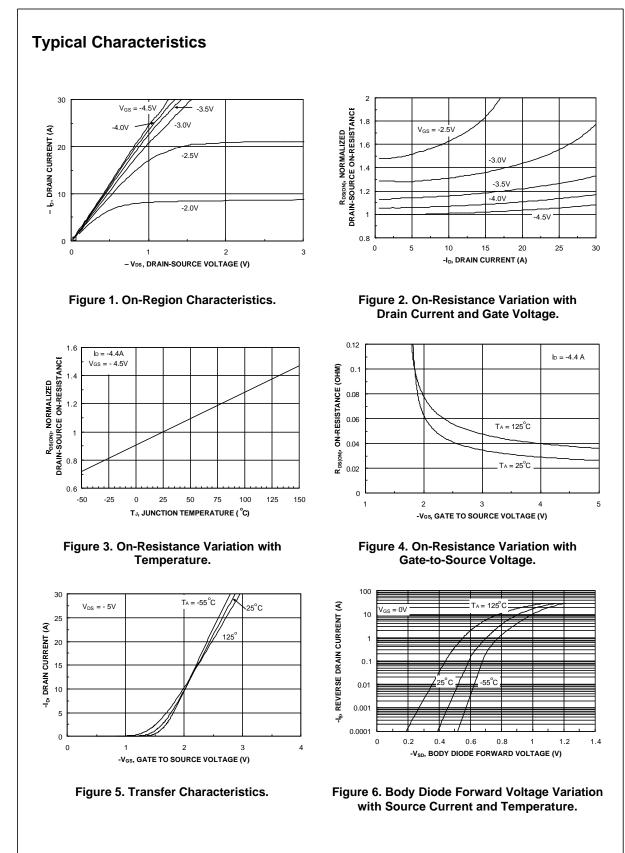
©2000 Fairchild Semiconductor Corporation

FDW2502P Rev. C1 (W)

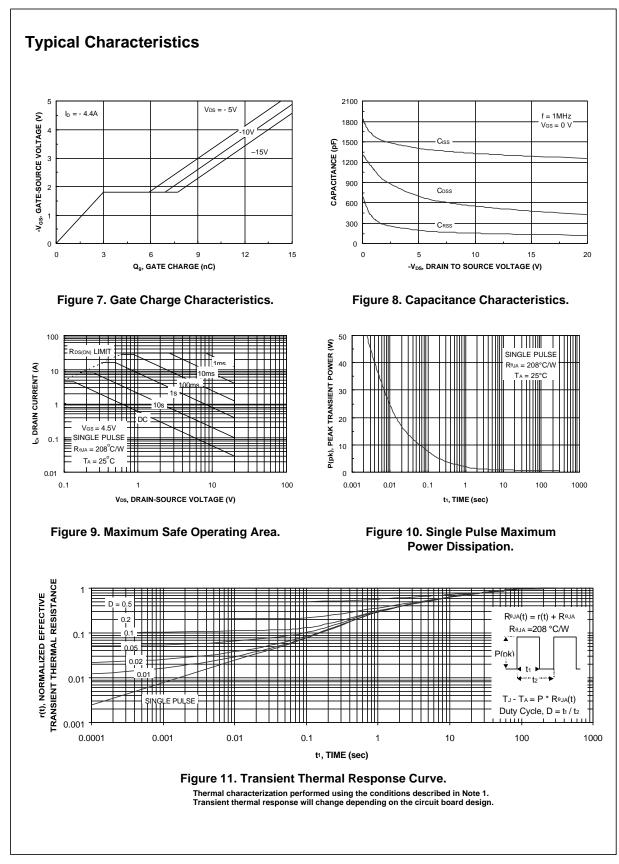
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Chai	racteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-17		mV/°
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V},  V_{GS} = 0 \text{ V}$			-1	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{GS} = -12 V$ , $V_{DS} = 0 V$			-100	nA
I <sub>GSSR</sub>	Gate-Body Leakage, Reverse	$V_{GS} = 12 V$ $V_{DS} = 0 V$			100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to $25^{\circ}$ C		3.1		mV/°
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V,  I_D = -4.4 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -4.4 \ , T_J = 125^\circ C \\ V_{GS} = -2.5 \ V,  I_D = -3.3 \ A \end{array} $		0.028 0.039 0.043	0.035 0.056 0.057	Ω
I <sub>D(on)</sub>	On-State Drain Current	$V_{\text{GS}} = -4.5 \text{ V}, \qquad V_{\text{DS}} = -5 \text{ V}$	-30			А
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 V$ , $I_{D} = -4.4 A$		17		S
Dynamic	c Characteristics					
C <sub>iss</sub>	Input Capacitance			1330		pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -10 V$ , $V_{GS} = 0 V$ , f = 1.0 MHz		552		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			153		pF
Switchir	ng Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time			12	25	ns
tr	Turn–On Rise Time	$V_{DD} = -10 \text{ V}, \qquad I_D = -1 \text{ A},$		19	40	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	$V_{GS} = -4.5$ V, $R_{GEN} = 6 \Omega$		60	100	ns
t <sub>f</sub>	Turn-Off Fall Time			37	70	ns
Q <sub>g</sub>	Total Gate Charge			14	20	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS} = -5 V,$ $I_D = -4.4 A,$ $V_{GS} = -4.5 V$		3.0		nC
Q <sub>gd</sub>	Gate-Drain Charge			3.9		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source	<b>v</b>			-0.83	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V},  I_{S} = -0.83 \text{ A} \text{ (Note 2)}$		-0.7	-1.2	V

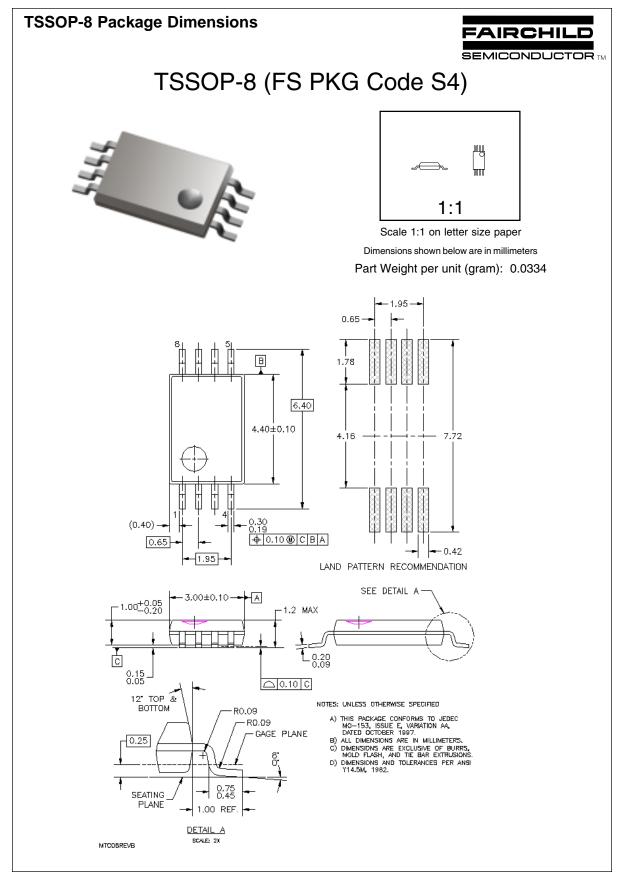
a) R<sub>eJA</sub> is 125°C/W (steady state) when mounted on a 1 inch<sup>2</sup> copper pad on FR-4.
b) R<sub>eJA</sub> is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

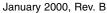
2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%



FDW2502P Rev. C1 (W)







### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx<sup>™</sup> Bottomless<sup>™</sup> CROSSVOLT<sup>™</sup> E<sup>2</sup>CMOS<sup>™</sup> FACT<sup>™</sup> FACT Quiet Series<sup>™</sup> FAST<sup>®</sup> FASTr<sup>™</sup> GTO<sup>™</sup> HiSeC<sup>™</sup> ISOPLANAR<sup>™</sup> MICROWIRE<sup>™</sup> POP<sup>™</sup> PowerTrench<sup>®</sup> QFET<sup>™</sup> QS<sup>™</sup> Quiet Series<sup>™</sup> SuperSOT<sup>™</sup>-3 SuperSOT<sup>™</sup>-6 SuperSOT<sup>™</sup>-8 SyncFET<sup>™</sup> TinyLogic<sup>™</sup> UHC<sup>™</sup> VCX<sup>™</sup>

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### **PRODUCT STATUS DEFINITIONS**

Definition of Terms

Datasheet Identification	Product Status	Definition			
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.			
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.			
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.			
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.			